



RESPONSE UNDER 37 CFR 1.116
EXPEDITED PROCEDURE

IN THE U.S. PATENT AND TRADEMARK OFFICE

May 12, 2011

Applicants: Toshihiro TAI et al
For: PLATED RESIN MOLDED ARTICLES
Serial No.: 10/586 378 Group: 1787
Confirmation No.: 2951
Filed: July 14, 2006 Examiner: Kruer
International Application No.: PCT/JP2005/002827
International Filing Date: February 16, 2005
Atty. Docket No.: 3400.P1434US

Mail Stop AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT AFTER FINAL REJECTION

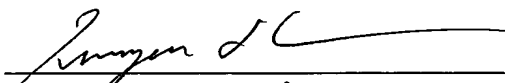
Sir:

In response to the Office Action dated February 16, 2011,
please amend the above-identified application as follows:

(Please see following pages.)

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being
deposited with the United States Postal Service with
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Terryence F. Chapman